

EVALUATION KIT MANUAL **AVAILABLE** High-Speed, Low-Power, Single-Supply Multichannel, Video Multiplexer-Amplifiers

General Description

The MAX4310-MAX4315 single-supply mux-amps combine high-speed operation, low-glitch switching, and excellent video specifications. The six products in this family are differentiated by the number of multiplexer inputs and the gain configuration. The MAX4310/ MAX4311/MAX4312 integrate 2-/4-/8-channel multiplexers, respectively, with an adjustable gain amplifier optimized for unity-gain stability. The MAX4313/MAX4314/ MAX4315 integrate 2-/4-/8-channel multiplexers, respectively, with a +2V/V fixed-gain amplifier. All devices have 40ns channel switching time and low 10mVp-p switching transients, making them ideal for video-switching applications. They operate from a single +4V to +10.5V supply, or from dual supplies of ±2V to ±5.25V, and they feature Rail-to-Rail® outputs and an input common-mode voltage range that extends to the negative supply rail.

19-1379; Rev 2; 12/02

The MAX4310/MAX4311/MAX4312 have a -3dB bandwidth of 280MHz/345MHz/265MHz and up to a 460V/µs slew rate. The MAX4313/MAX4314/MAX4315, with 150MHz/127MHz/97MHz -3dB bandwidths up to a 540V/µs slew rate, and a fixed gain of +2V/V, are ideally suited for driving back-terminated cables. Quiescent supply current is as low as 6.1mA, while low-power shutdown mode reduces supply current to as low as 560µA and places the outputs in a high-impedance state. The MAX4310-MAX4315's internal amplifiers maintain an open-loop output impedance of only 8Ω over the full output voltage range, minimizing the gain error and bandwidth changes under loads typical of most rail-to-rail amplifiers. With differential gain and phase errors of 0.06% and 0.08°, respectively, these devices are ideal for broadcast video applications.

Applications

Video Signal Multiplexing Video Crosspoint Switching Flash ADC Input Buffers 75Ω Video Cable Drivers High-Speed Signal Processing

Broadcast Video Medical Imaging Multimedia Products

Features

- ♦ Single-Supply Operation Down to +4V
- ♦ 345MHz -3dB Bandwidth (MAX4311) 150MHz -3dB Bandwidth (MAX4313)
- ♦ 540V/µs Slew Rate (MAX4313)
- ♦ Low 6.1mA Quiescent Supply Current
- ♦ 40ns Channel Switching Time
- ♦ Ultra-Low 10mVp-p Switching Transient
- ♦ 0.06%/0.08° Differential Gain/Phase Error
- ♦ Rail-to-Rail Outputs: Drives 150Ω to within 730mV of the Rails
- ♦ Input Common-Mode Range Includes **Negative Rail**
- **♦ Low-Power Shutdown Mode**
- ♦ Available in Space-Saving 8-Pin µMAX and 16-Pin QSOP Packages

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX4310EUA	-40°C to +85°C	8 µMAX
MAX4310ESA	-40°C to +85°C	8 SO
MAX4311EEE	-40°C to +85°C	16 QSOP
MAX4311ESD	-40°C to +85°C	14 Narrow SO
MAX4312EEE	-40°C to +85°C	16 QSOP
MAX4312ESE	-40°C to +85°C	16 Narrow SO
MAX4313EUA	-40°C to +85°C	8 µMAX
MAX4313ESA	-40°C to +85°C	8 SO
MAX4314EEE	-40°C to +85°C	16 QSOP
MAX4314ESD	-40°C to +85°C	14 Narrow SO
MAX4315EEE	-40°C to +85°C	16 QSOP
MAX4315ESE	-40°C to +85°C	16 Narrow SO

Pin Configurations and Typical Operating Circuit appear at end of data sheet.

Rail-to-Rail is a registered trademark of Nippon Motorola, Ltd.

Selector Guide

PART	NO. OF INPUT CHANNELS	AMPLIFIER GAIN (V/V)	PIN-PACKAGE
MAX4310	2	≥ + 1	8-Pin SO/µMAX
MAX4311	4	≥ + 1	14-Pin Narrow SO, 16-Pin QSOP
MAX4312	8	≥ + 1	16-Pin Narrow SO/QSOP
MAX4313	2	+2	8-Pin SO/µMAX
MAX4314	4	+2	14-Pin Narrow SO, 16-Pin QSOP
MAX4315	8	+2	16-Pin Narrow SO/QSOP

MIXIM

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VCC to VEE)	12V
	(VEE - 0.3V) to (VCC + 0.3V)
All Other Pins	$(V_{EE} - 0.3V)$ to $(V_{CC} + 0.3V)$
Output Current	±120mA
	GND, VCC or VEE)Continuous
Continuous Power Dissipation ($T_A = +70^{\circ}C$
8-Pin SO (derate 5.9mW/°C al	bove +70°C)471mW
8-Pin µMAX (derate 4.1mW/°C	C above +70°C)330mW

14-Pin SO (derate 8.3mW/°C above +70°C)	
16-Pin SO (derate 8.7mW/°C above +70°C)	696mW
16-Pin QSOP (derate 8.3mW/°C above +70°C)	667mW
Operating Temperature Range	10°C to +85°C
Storage Temperature Range65	
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

(VCC = +5V, VEE = 0V, SHDN ≥ 4V, RL = ∞, VOUT = 2.5V, TA = TMIN to TMAX, unless otherwise noted. Typical values are at TA = +25°C.)

PARAMETER	SYMBOL	CON	DITIONS	MIN	TYP	MAX	UNITS
Operating Supply Voltage Range	V _C C	Inferred from PSRR te	st	4.0		10.5	V
land Vallage Danie		MAX4310/MAX4311/N CMRR test	1AX4312, inferred from	0.035	V(_{CC} - 2.8	V
Input Voltage Range		MAX4313/MAX4314/Noutput voltage swing	1AX4315, inferred from	0.035	Vo	CC - 2.7	V
Common-Mode Rejection Ratio	CMRR	$0 \le V_{CM} \le 2.2V$, MAX- only	4310/MAX4311/MAX4312	73	95		dB
Input Offset Voltage	Vos				±5.0	±20	mV
Input Offset Voltage Drift	TC _{VOS}				±7		μV/°C
Input Offset Voltage Matching				±1		mV	
Input Bias Current	ΙΒ	I _{IN}			7	14	μΑ
Feedback Bias Current	I _{FB}	I _{FB} , MAX4310/MAX43	11/MAX4312 only		7	14	μΑ
Input Offset Current	Ios	MAX4310/MAX4311/N	1AX4312 only		0.1	2	μΑ
Common-Mode Input Resistance	R _{IN}	V _{IN} varied over V _{CM} , N MAX4312 only	MAX4310/MAX4311/		3		МΩ
Differential Input Resistance	R _{IN}				70		ΚΩ
		MAX4310/MAX4311/	Open loop		8		
Output Resistance	Rout	MAX4312 only	Closed loop, $A_V = +1V/V$		0.025		Ω
		MAX4313/MAX4314/N	1AX4315		0.025		
Disabled Output Resistance	Rout	MAX4310/MAX4311/M	1AX4312, open loop		35		Ω
Disabled Output Hesistance	11001	MAX4313/MAX4314/MAX4315			1		52
Open-Loop Gain	Avol	MAX4310/MAX4311/N R _L = 150 Ω to GND, 0.	50	59		dB	
Voltage Gain	Avcl	MAX4313/MAX4314/M R _L = 150 Ω to GND, 0.		1.9	2.0	2.1	V/V

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = \infty, V_{OUT} = 2.5V, T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}C$.)

PARAMETER	SYMBOL	COND	DITIONS	MIN	TYP	MAX	UNITS
		D: 1500	VCC - VOH		0.73	0.9	
Output Valtage Swing	\/a	$R_L = 150\Omega$	V _{OL} - V _{EE}		0.03	0.06	V
Output Voltage Swing	Vout	$R_{l} = 10k\Omega$	VCC - VOH		0.25	0.4	V
		H[= 10K22	V _{OL} - V _{EE}		0.04	0.07	
Output Current	lout	$R_L = 30\Omega$		±75	±95		mA
Power-Supply Rejection Ratio	PSRR	V _{CC} = 4.0V to 10.5V		52	63		dB
		MAX4310/MAX4313		6.1	7.8		
Quiescent Supply Current	Icc	MAX4311/MAX4314			6.9	8.8	mA
		MAX4312/MAX4315		7.4	9.4		
Shutdown Supply Current		SHDN ≤ V _{IL}			560	750	μΑ
LOGIC CHARACTERISTICS	SHDN, A0, A	1, A2)					
Logic-Low Threshold	V_{IL}					V _{EE} + 1	V
Logic-High Threshold	V _{IH}			V _{CC} - 1		·	V
Logic-Low Input Current	IJЦ	V _{IL} ≤ V _{EE} + 1V	-500	-320		μΑ	
Logic-High Input Current	lін	V _{IH} ≥ V _{CC} - 1V		0.3	5	μΑ	

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +5V, \ V_{EE} = 0V, \ \overline{SHDN} \ge 4V, \ R_L = 150\Omega, \ V_{CM} = 1.5V, \ A_{VCL} = +1V/V \ (MAX4310/MAX4311/MAX4312), \ A_{VCL} = +2V/V \ (MAX4313/MAX4314/MAX4315), \ T_A = +25^{\circ}C, \ unless \ otherwise \ noted.)$

PARAMETER	SYMBOL	CONDIT	TONS	MIN	TYP	MAX	UNITS
			MAX4310		280		
			MAX4311		345		
-3dB Bandwidth	DW(a IB)	Va. = 100m\/n n	MAX4312		265		NALI→
-Sub Danuwidin	BW _(-3dB)	$V_{OUT} = 100 \text{mVp-p}$	MAX4313		150		MHz
			MAX4314		127		
			MAX4315		97		
			MAX4310		60		
			MAX4311		40		
O 1 dD Donaly violable	DW	V 100maVm m	MAX4312		35		
-0.1dB Bandwidth	BW(-0.1dB)	V _{OUT} = 100mVp-p	MAX4313		40		MHz
			MAX4314		78		
			MAX4315		46		

AC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega, V_{CM} = 1.5V, A_{VCL} = +1V/V (MAX4310/MAX4311/MAX4312), A_{VCL} = +2V/V (MAX4313/MAX4314/MAX4315), T_A = +25°C, unless otherwise noted.)$

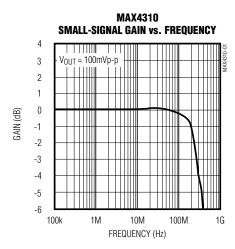
PARAMETER	SYMBOL		CONDITIONS		MIN	TYP	MAX	UNITS
			MAX4310			110		İ
			MAX4311		100		1	
5 H D D J 1 H	FPBW	., .,	MAX4312			80		1
Full-Power Bandwidth		V _{OUT} = 2Vp-p	MAX4313		40		MHz	
			MAX4314		90 70			1
			MAX4315					1
			MAX4310			460		
			MAX4311			430		
Claur Data	CD)/ O)/	MAX4312			345		
Slew Rate	SR	V _{OUT} = 2Vp-p	MAX4313			540		
			MAX4314			430		
			MAX4315			310		
O-Hi Tim t- 0.40/		0)/	MAX4310/MAX	X4311/MAX4312		42		
Settling Time to 0.1%	ts	V _{OUT} = 2Vp-p	MAX4313/MAX	X4314/MAX4315		25		ns
Gain Matching		Matching between bandwidth	en channels over	r -3dB		0.05		dB
Differential Gain Error	DG	AVCL = $+1V/V$, R _L = 150Ω to VCC/2	MAX4310/MA MAX4312	AX4311/		0.06		%
		$R_L = 150\Omega$ to $V_{CC}/2$	MAX4313/MA MAX4315		0.09			
Differential Phase Error	DG	AVCL = $+1V/V$, R _L = 150Ω to VCC/2	MAX4310/MA MAX4312	X4311/		0.08		degrees
		$R_L = 150\Omega$ to $V_{CC}/2$	MAX4313/MA MAX4315	X4314/		0.03		
			MAX4310/	f = 3kHz		-89		
			MAX4311/	f = 2kHz		-80		1
Spurious-Free Dynamic	0===	İ	MAX4312	f = 20kHz		-47		j
Range	SFDR	V _{OUT} = 2Vp-p	MAX4313/	f = 3kHz		-95		dBc
		•	MAX4314/	f = 2kHz		-72		1
			MAX4315	f = 20kHz		-47		1
		f = 1MHz,	MAX4310/MAX	X4311/MAX4312		-85		1.
Second Harmonic Distortion		$V_{OUT} = 2V_{p-p}$	MAX4313/MAX4314/MAX4315			-76		dBc
		f = 1MHz,	•	X4311/MAX4312		-88		<u> </u>
Third Harmonic Distortion		$V_{OUT} = 2V_{p-p}$	MAX4313/MAX4314/MAX4315			-95	dBc	
		f = 1MHz,	-	X4311/MAX4312		-83		
Total Harmonic Distortion THD THD THD THD THD THD		MAX4313/MAX		-76		dBc		

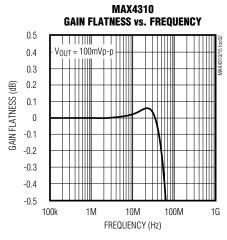
AC ELECTRICAL CHARACTERISTICS (continued)

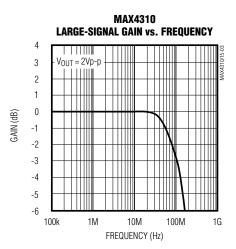
 $(V_{CC} = +5V, V_{EE} = 0V, \overline{SHDN} \ge 4V, R_L = 150\Omega, V_{CM} = 1.5V, A_{VCL} = +1V/V (MAX4310/MAX4311/MAX4312), A_{VCL} = +2V/V (MAX4313/MAX4314/MAX4315), T_A = +25°C, unless otherwise noted.)$

PARAMETER	SYMBOL		MIN	TYP	MAX	UNITS					
		(4014)	MAX4310/MAX4313		-95						
All-Hostile Crosstalk		f = 10MHz, V _{IN} = 2Vp-p	MAX4311/MAX4314		-60		dB				
		ν IIV – Σνρ-ρ	MAX4312MAX4315		-52						
Off-Isolation		SHDN = 0, f = 10	OMHz, V _{IN} = 2Vp-p		-82		dB				
Output Impedance	Zout	f = 10MHz			3		Ω				
Input Capacitance	CIN	Channel on or of	ff		2		pF				
Input Voltage-Noise Density	en	f = 10kHz			14		nV/√Hz				
Input Current-Noise Density	in	f = 10kHz			1.3		pA/√Hz				
SWITCHING CHARACTERIST	TICS										
Channel Switching Time	tsw				40		ns				
Enable Time from Shutdown	ton								50		ns
Disable Time to Shutdown	toff				120		ns				
Switching Transient					10		mVp-p				

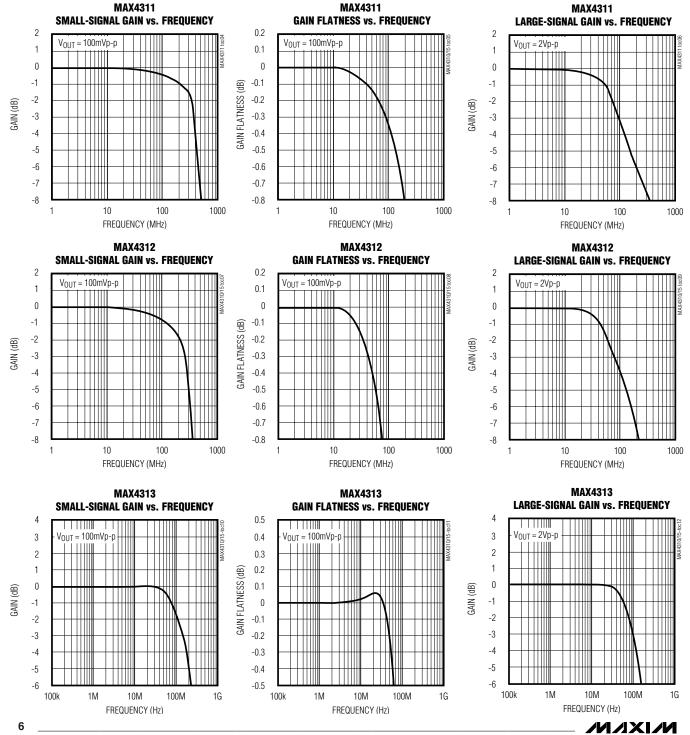
_Typical Operating Characteristics



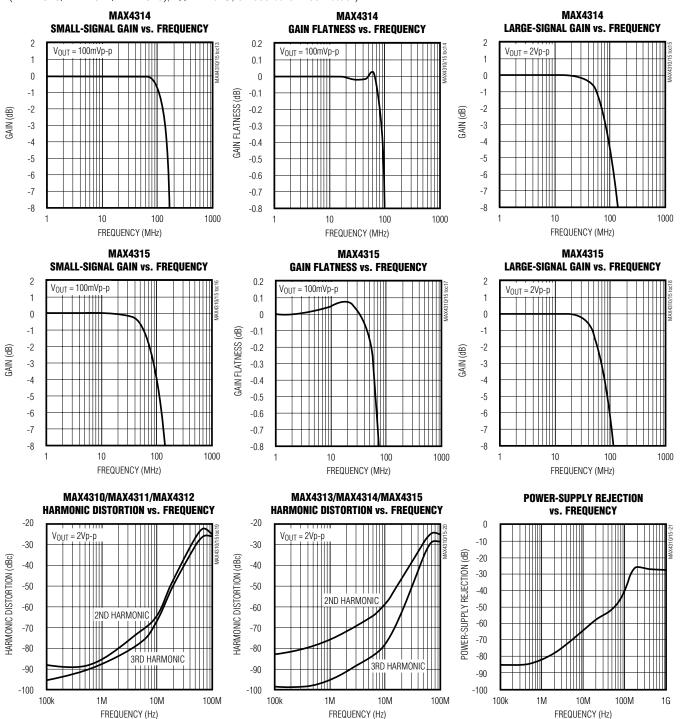




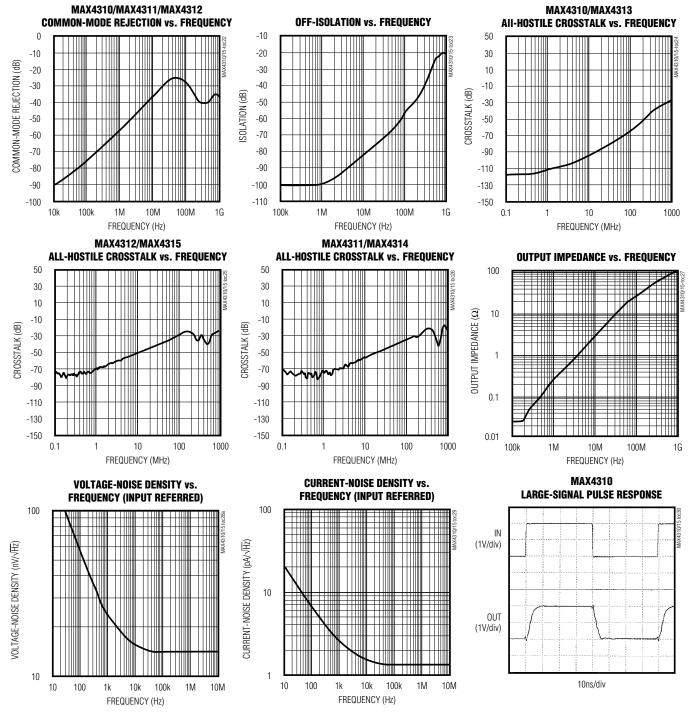
Typical Operating Characteristics (continued)



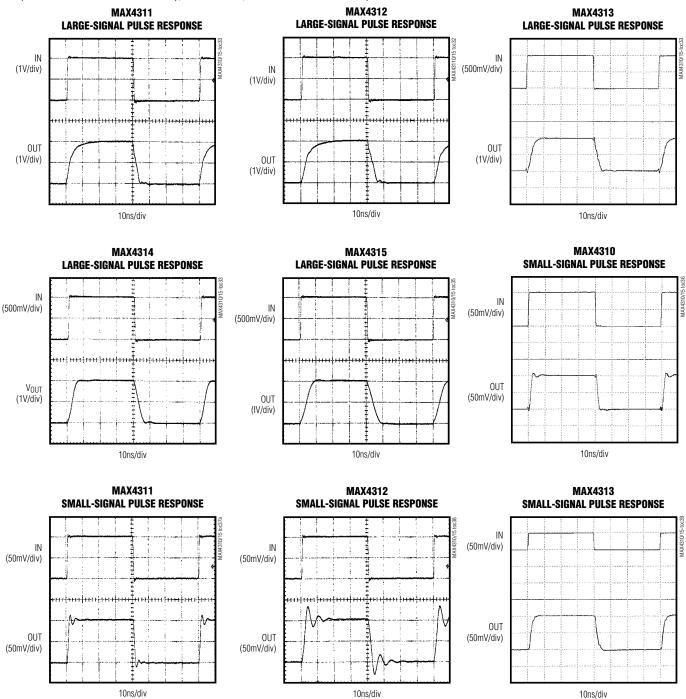
Typical Operating Characteristics (continued)



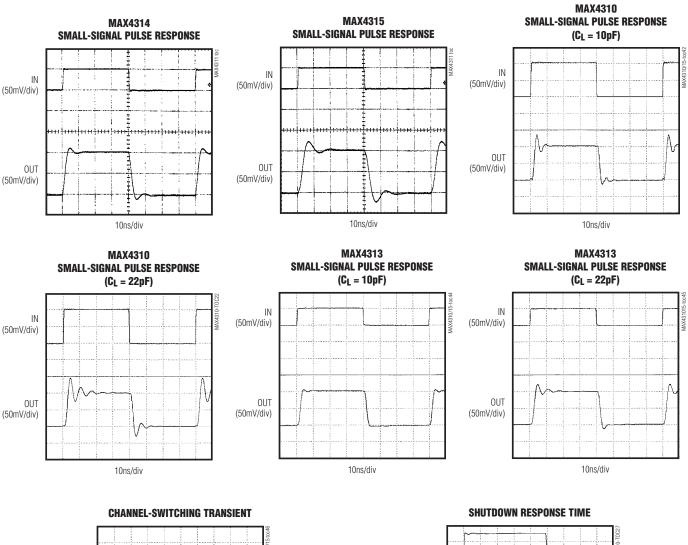
Typical Operating Characteristics (continued)

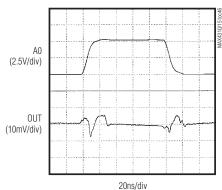


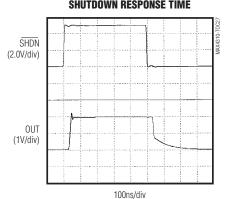
Typical Operating Characteristics (continued)



Typical Operating Characteristics (continued)







Pin Description

			ļ						
MAX4310 MAX		X4311	MAX4312 SO/QSOP	MAX4313 MAX4314 SO/μΜΑΧ		X4314	MAX4315 SO/QSOP	NAME	FUNCTION
30/µIVIAX	so	QSOP	30/Q30F	30/µIMAX	SO	QSOP	30/Q30P		
1	2	2	3	1	2	2	3	A0	Channel Address Logic Input 0
_	1	1	2	_	1	1	2	A1	Channel Address Logic Input 1
_	_	_	1	_	_	_	1	A2	Channel Address Logic Input 2
2	12	14	14	2	12	14	14	SHDN	Shutdown Input
3	4	4	4	3	4	4	4	Vcc	Positive Power Supply
4	5	5	5	4	5	5	5	IN0	Amplifier Input 0
5	7	7	6	5	7	7	6	IN1	Amplifier Input 1
_	8	10	7	_	8	10	7	IN2	Amplifier Input 2
_	10	12	8	_	10	12	8	IN3	Amplifier Input 3
_	_	_	9	_	_	_	9	IN4	Amplifier Input 4
_		_	10	_	_	_	10	IN5	Amplifier Input 5
_	_	_	11	_	_	_	11	IN6	Amplifier Input 6
_	_	_	12	_	_	_	12	IN7	Amplifier Input 7
6	11	13	13	6	11	13	13	VEE	Negative Power Supply. Ground for single-supply operation.
7	13	15	15	_	_	_	_	FB	Amplifier Feedback Input
_	_	_	_	7	13	15	15	GND	Ground
8	14	16	16	8	14	16	16	OUT	Amplifier Output
_	3, 6, 9	3, 6, 8, 9, 11	_	_	3, 6, 9	3, 6, 8, 9, 11	_	N.C.	Not connected. Tie to ground plane for optimal performance.

Detailed Description

The MAX4310/MAX4311/MAX4312 combine 2-channel, 4-channel, or 8-channel multiplexers, respectively, with an adjustable-gain output amplifier optimized for closed-loop gains of +1V/V (0dB) or greater. The MAX4313/MAX4314/MAX4315 combine 2-channel, 4channel, or 8-channel multiplexers, respectively, with a +2V/V (6dB) fixed-gain amplifier, optimized for driving back-terminated cables. These devices operate from a single supply voltage of +4V to +10.5V, or from dual supplies of ±2V to ±5.25V. The outputs may be placed in a high-impedance state and the supply current minimized by forcing the SHDN pin low. The input multiplexers feature short 40ns channel-switching times and small 10mVp-p switching transients. The input capacitance remains constant at 1pF whether the channel is on or off, providing a predictable input impedance to the signal source. These devices feature single-supply, rail-to-rail, voltage-feedback output amplifiers that achieve up to 540V/µs slew rates and up to 345MHz -3dB bandwidths. These devices also feature excellent harmonic distortion and differential gain/phase performance.

Applications Information

Rail-to-Rail Outputs, Ground-Sensing Input

The input common-mode range extends from the negative supply rail to V_{CC} - 2.7V with excellent common-mode rejection. Beyond this range, multiplexer switching times may increase and the amplifier output is a nonlinear function of the input, but does not undergo phase reversal or latchup.

The output swings to within 250mV of VCC and 40mV of VEE with a $10k\Omega$ load. With a 150Ω load to ground, the output swings from 30mV above VEE to within 730mV of

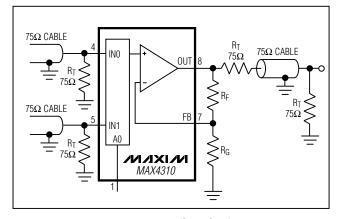


Figure 1. MAX4310 Noninverting Gain Configuration

the supply rail. Local feedback around the output stage ensures low open-loop output impedance to reduce gain sensitivity to load variations. This feedback also produces demand-driven bias current to the output transistors for ±95mA drive capability while constraining total supply current to only 6.1mA.

Feedback and Gain Resistor Selection (MAX4310/MAX4311/MAX4312)

Select the MAX4310/MAX4311/MAX4312 gain-setting feedback (RF) and input (RG) resistors to fit your application. Large resistor values increase voltage noise and interact with the amplifier's input and PC board capacitance. This can generate undesirable poles and zeros, and can decrease bandwidth or cause oscillations. For example, a noninverting gain of +2V/V configuration (RF = RG) using 1k Ω resistors, combined with 2pF of input capacitance and 1pF of PC board capacitance, causes a pole at 159MHz. Since this pole is within the amplifier bandwidth, it jeopardizes stability. Reducing the 1k Ω resistors to 100 Ω extends the pole frequency to 1.59GHz, but could limit output swing by adding 200 Ω in parallel with the amplifier's load resistor.

Table 1 shows suggested RF and RG values for the MAX4310/MAX4311/MAX4312 when operating in the noninverting configuration (shown in Figure 1). These values provide optimal AC response using surface-mount resistors and good layout techniques, as discussed in the Layout and Power-Supply Bypassing section.

Stray capacitance at the FB pin causes feedback resistor decoupling and produces peaking in the frequency-response curve. Keep the capacitance at FB as low as possible by using surface-mount resistors and by avoiding the use of a ground plane beneath or beside these resistors and the FB pin. Some capacitance is unavoidable; if necessary, its effects can be neutralized by adjusting RF. Use 1% resistors to maintain consistency over a wide range of production lots.

Table 1. Bandwidth and Gain with Suggested Gain-Setting resistors (MAX4310/MAX4311/MAX4312)

GAIN (V/V)	GAIN (d B)	R F (Ω)	R _G (Ω)	-3dB BW (MHz)	0.1dB BW (MHz)
1	0	0	∞	280	60
2	6	500	500	80	30
5	14	500	120	20	4
10	20	500	56	10	2

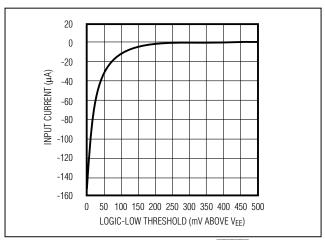


Figure 2. Logic-Low Input Current vs. VIL (SHDN, A0, A1, A2)

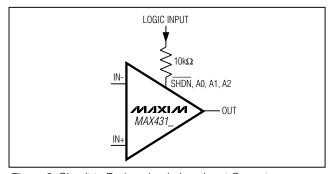


Figure 3. Circuit to Reduce Logic-Low Input Current

Low-Power Shutdown Mode

All parts feature a low-power shutdown mode that is activated by driving the \overline{SHDN} input low. Placing the amplifier in shutdown mode reduces the quiescent supply current to $560\mu A$ and places the output into a high-impedance state, typically $35k\Omega.$ By tying the outputs of several devices together and disabling all but one of the paralleled amplifiers' outputs, multiple devices may be paralleled to construct larger switch matrices.

For MAX4310/MAX4311/MAX4312 application circuits operating with a closed-loop gain of +2V/V or greater, consider the external-feedback network impedance of all devices used in the mux application when calculating the total load on the output amplifier of the active device. The MAX4313/MAX4314/MAX4315 have a fixed gain of +2V/V that is internally set with two 500 Ω thin-film resistors. The impedance of the internal feedback resistors must be taken into account when operating multiple MAX4313/MAX4314/MAX4315s in large multiplexer applications. For normal operation, drive $\overline{\rm SHDN}$ high. If the shutdown function is not used, connect $\overline{\rm SHDN}$ to Vcc.

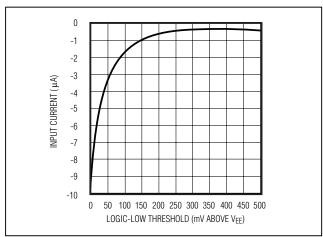


Figure 4. Logic-Low Input Current vs. V_{IL} with $10k\Omega$ Series Resistor

Layout and Power-Supply Bypassing

The MAX4310–MAX4315 have very high bandwidths and consequently require careful board layout, including the possible use of constant-impedance microstrip or stripline techniques.

To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing and board layout. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible, with one exception: the feedback (FB) should have as low a capacitance to ground as possible. Therefore, layers that do not incorporate a signal or power trace should not have a ground plane.

Whether or not a constant-impedance board is used, it is best to observe the following guidelines when designing the board:

- 1) Do not use wire-wrapped boards (they are too inductive) or breadboards (they are too capacitive).
- Do not use IC sockets; they increase parasitic capacitance and inductance.
- 3) Keep signal lines as short and straight as possible. Do not make 90° turns; round all corners.
- 4) Observe high-frequency bypassing techniques to maintain the amplifier's accuracy and stability.
- 5) Use surface-mount components. They generally have shorter bodies and lower parasitic reactance, yielding better high-frequency performance than through-hole components.

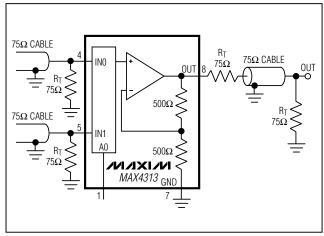


Figure 5. Video Line Driver

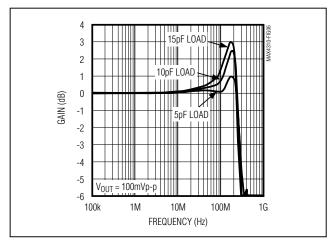


Figure 6. Small-Signal Gain vs. Frequency with a Capacitive Load and No-Isolation Resistor

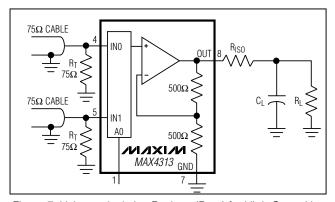


Figure 7. Using an Isolation Resistor (RISO) for High-Capacitive Loads

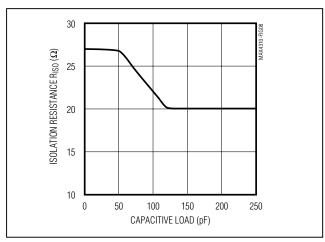


Figure 8. Optimal Isolation Resistance vs. Capacitive Load

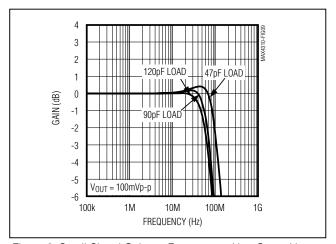


Figure 9. Small-Signal Gain vs. Frequency with a Capacitive Load and 27Ω No-Isolation Resistor

The bypass capacitors should include a 100nF, ceramic surface-mount capacitor between each supply pin and the ground plane, located as close to the package as possible. Optionally, place a 10µF tantalum capacitor at the power-supply pin's point of entry to the PC board to ensure the integrity of incoming supplies. The power-supply trace should lead directly from the tantalum capacitor to the VCC and VEE pins. To minimize parasitic inductance, keep PC traces short and use surface-mount components. If input termination resistors and output back-termination resistors are used, they should be surface-mount types, and should be placed as close to the IC pins as possible.

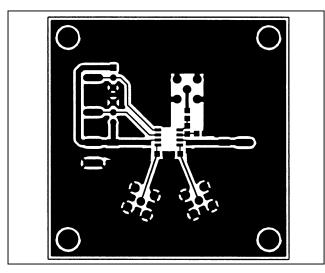


Figure 10. High-Speed EV Board Layout—Component Side

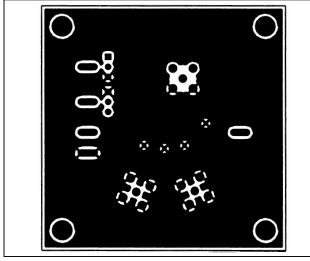


Figure 11. High-Speed EV Board Layout—Solder Side

Video Line Driver

The MAX4310–MAX4315 are well-suited to drive coaxial transmission lines when the cable is terminated at both ends, as shown in Figure 5. Cable frequency response can cause variations in the signal's flatness.

Driving Capacitive Loads

A correctly terminated transmission line is purely resistive and presents no capacitive load to the amplifier. Reactive loads decrease phase margin and may produce excessive ringing and oscillation (see *Typical Operating Characteristics*).

Table 2. Input Control Logic

MAX4310/MAX4313											
SHDN	A2	A 1	A0	CHANNEL SELECTED							
0	_	_	Χ	None, High-Z Output							
1	_	_	0	0							
1	_	_	1	1							
	MAX4311/MAX4314										
SHDN	A2	A 1	Α0	CHANNEL SELECTED							
0	_	Χ	Χ	None, High-Z Output							
1	_	0	0	0							
1	_	0	1	1							
1	_	1	0	2							
1	_	1	1	3							
		MAX	4312/M <i>A</i>	AX4315							
SHDN	A2	A 1	Α0	CHANNEL SELECTED							
0	Χ	Χ	Χ	None, High-Z Output							
1	0	0	0	0							
1	0	0	1	1							
1	0	1	0	2							
1	0	1	1	3							
1	1	0	0	4							
1	1	0	1	5							
1	1	1	0	6							
-				7							

Another concern when driving capacitive loads originates from the amplifier's output impedance, which appears inductive at high frequencies. This inductance forms an L-C resonant circuit with the capacitive load, which causes peaking in the frequency response and degrades the amplifier's phase margin.

Although the MAX4310–MAX4315 are optimized for AC performance and are not designed to drive highly capacitive loads, they are capable of driving up to 20pF without oscillations. However, some peaking may occur in the frequency domain (Figure 6). To drive larger capacitive loads or to reduce ringing, add an isolation resistor between the amplifier's output and the load (Figure 7).

The value of RISO depends on the circuit's gain and the capacitive load (Figure 8). Figure 9 shows the MAX4310–MAX4315 frequency response with the isolation resistor and a capacitive load. With higher capacitive values, bandwidth is dominated by the RC network formed by RISO and CL; the bandwidth of the amplifier itself is much higher. Also note that the isolation resistor forms a divider that decreases the voltage delivered to the load.

Digital Interface

The multiplexer architecture of the MAX4310–MAX4315 ensures that no two input channels are ever connected together. Channel selection is accomplished by applying a binary code to channel address inputs. The address decoder selects input channels, as shown in Table 2. All digital inputs are CMOS compatible.

High-Speed Evaluation Board

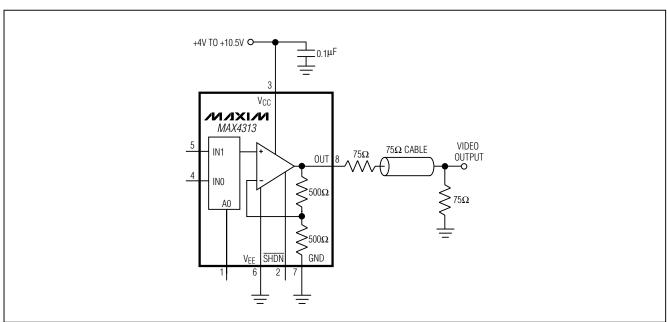
Figures 10 and 11 show the evaluation board and present a suggested layout for the circuits. This board was developed using the techniques described in the Layout and Power-Supply Bypassing section. The smallest available surface-mount resistors were used for feedback and back-termination to minimize their distance from the part, reducing the capacitance associated with longer lead lengths.

SMA connectors were used for best high-frequency performance. Inputs and outputs do not match a 75Ω line, but this does not affect performance since distances are extremely short. However, in applications that require lead lengths greater than one-quarter of the wavelength of the highest frequency of interest, use constant-impedance traces. Fully assembled evaluation boards are available for the MAX4313 in an SO package.

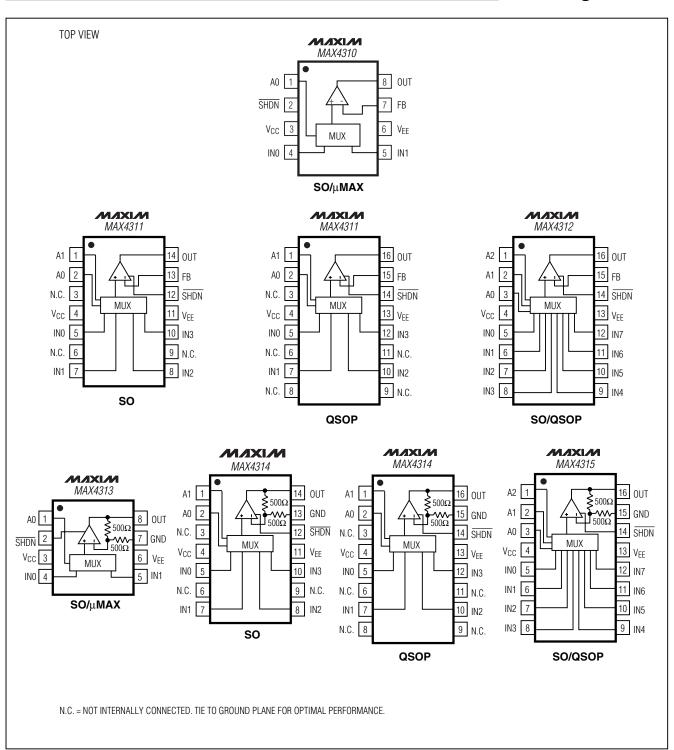
Chip Information

TRANSISTOR COUNT: 156

Typical Operating Circuit

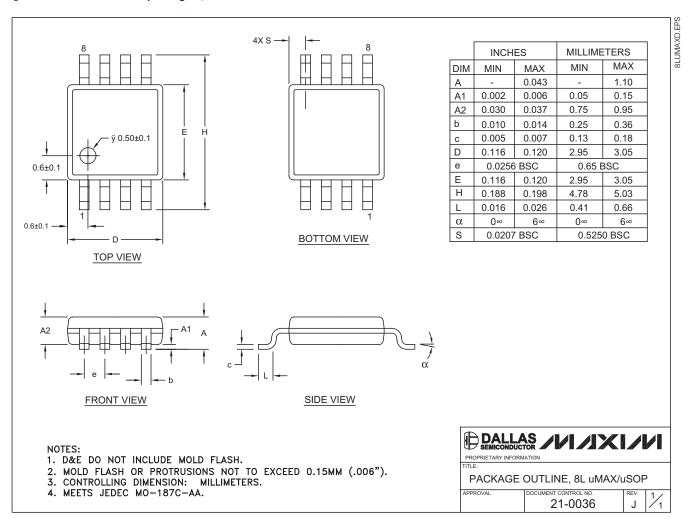


Pin Configurations



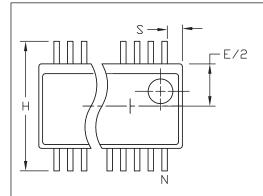
Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

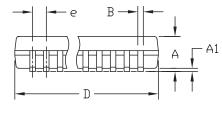


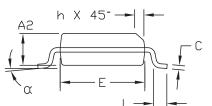
Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



	INCHES		MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	.061	.068	1.55	1.73		
A1	.004	.0098	0.102	0.249		
A2	.055	.061	1.40	1.55		
В	.008	.012	0.20	0.31		
С	.0075	.0098	0.191	0.249		
D	SEE VARIATIONS					
Ε	.150	.157	3.81	3.99		
е	.025 BSC		0.635 BSC			
Н	.230	.244	5.84	6.20		
h	.010	.016	0.25	0.41		
L	.016	.035	0.41	0.89		
N	SEE VARIATIONS					
α	0*	8°	0°	8*		





	INCHES		MILLIMETERS			
	MIN.	MAX.	MIN.	MAX.	N	
D	.189	.196	4.80	4.98	16	АΑ
S	.0020	.0070	0.05	0.18		
D	.337	.344	8.56	8.74	20	ΑВ
S	.0500	.0550	1.270	1.397		
D	.337	.344	8.56	8.74	24	AC
S	.0250	.0300	0.635	0.762		
D	.386	.393	9.80	9.98	28	ΑD
S	.0250	.0300	0.635	0.762		

NOTES:

- 1). D & E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 2). MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .006" PER SIDE.
- 3). CONTROLLING DIMENSIONS: INCHES. 4). MEETS JEDEC MO137.

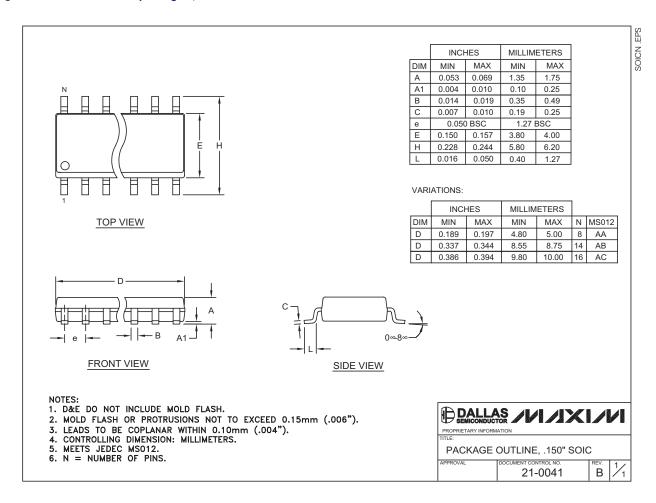


PACKAGE DUTLINE, QSDP, .150", .025" LEAD PITCH
APPROVAL | DOCUMENT CONTROL NO. | REV 21-0055 D

MIXIM

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



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